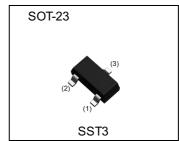


NPN Medium Power Transistor (Switching)

| Parameter | Value | | |
|------------------|-------|--|--|
| V _{CEO} | 40V | | |
| I _C | 600mA | | |

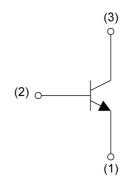
Outline



Features

1)BV_{CEO}=40V(Min.); at I_C=1mA 2)Complements the SST4403.

•Inner circuit



- (1) Emitter
- (2) Base
- (3) Collector

Application

AUDIO FREQUENCY SMALL SIGNAL AMPLIFIER

Packaging specifications

| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Basic ordering unit.(pcs) | Marking |
|----------|------------------|-----------------|----------------|-------------------|-----------------|---------------------------------|---------|
| SST4401 | SOT-23 (SST3) | 2924 | T116 | 180 | 8 | 3000 | R2X |

● Absolute maximum ratings (T_a = 25°C)

| Parameter | Symbol | Values | Unit |
|------------------------------|-------------------|-------------|------|
| Collector-base voltage | V_{CBO} | 60 | V |
| Collector-emitter voltage | V _{CEO} | 40 | V |
| Emitter-base voltage | V _{EBO} | 6 | V |
| Collector current | I _C | 600 | mA |
| Device discinction | P _D *1 | 200 | mW |
| Power dissipation | P _D *2 | 350 | mW |
| Junction temperature | T _j | 150 | °C |
| Range of storage temperature | T _{stg} | -55 to +150 | °C |

● Electrical characteristics (T_a = 25°C)

| Parameter | Symbol | Conditions | Values | | | Unit |
|--------------------------------------|--------------------------|---|--------|------|------|-------|
| raiainetei | Symbol | Conditions | Min. | Тур. | Max. | UIIIL |
| Collector-base breakdown voltage | BV _{CBO} | BV_{CBO} $I_C = 100 \mu A$ | | - | - | V |
| Collector-emitter breakdown voltage | BV _{CEO} | I _C = 1mA | 40 | - | - | V |
| Emitter-base breakdown voltage | BV _{EBO} | I _E = 100μA | 6 | - | - | V |
| Collector cut-off current | I _{CBO} | V _{CB} = 35V | 1 | • | 100 | nA |
| Emitter cut-off current | I _{EBO} | V _{EB} = 5V | 1 | - | 100 | nA |
| Collector emitter acturation valtage | V _{CE(sat)} 1 | I _C = 150mA, I _B = 15mA | 1 | 1 | 400 | mV |
| Collector-emitter saturation voltage | V _{CE(sat)} 2*3 | $I_C = 500 \text{mA}, I_B = 50 \text{mA}$ | 1 | - | 750 | mV |
| Base-emitter saturation voltage | V _{BE(sat)} 1 | I _C = 150mA, I _B = 15mA | 1 | - | 950 | mV |
| | V _{BE(sat)} 2*3 | $I_C = 500 \text{mA}, I_B = 50 \text{mA}$ | 1 | - | 1.2 | V |
| | h _{FE} 1 | $V_{CE} = 1V, I_{C} = 100 \mu A$ | 20 | - | - | - |
| | h _{FE} 2 | V _{CE} = 1V, I _C = 1mA | 40 | - | - | - |
| DC current gain | h _{FE} 3 | V _{CE} = 1V, I _C = 10mA | 80 | - | - | - |
| | h _{FE} 4 | V _{CE} = 1V, I _C = 150mA | 100 | - | 300 | - |
| | h _{FE} 5*3 | V _{CE} = 2V, I _C = 500mA | 40 | - | - | - |
| Output capacitance | C _{ob} | $V_{CB} = 10V, I_{E} = 0A$ f = 100kHz | - | - | 6.5 | pF |
| Input capacitance | C _{ib} | $V_{BE} = 0.5V, I_{C} = 0A$ f = 100kHz | - | - | 30 | pF |
| Transition frequency | f _T | $V_{CE} = 10V, I_{E} = -20mA$ f = 100MHz | 250 | - | - | MHz |
| Delay time | t _d | $V_{CC} \approx 30V, I_{C} = 150mA$ $I_{B1} = 15mA, R_{I} = 200\Omega$ | - | - | 15 | ns |
| Rise time | t _r | V _{BE(off)} = -2V See test circuit | 1 | - | 20 | ns |
| Storage time | t _{stg} | $V_{CC} \approx 30V$ $I_C = 150mA$ | - | - | 225 | ns |
| Fall time | t _f | I_{B1} = 15mA I_{B2} = -15mA, R_L = 200 Ω See test circuit | - | - | 30 | ns |

^{*1} Each terminal mounted on a reference land.

^{*2} Mounted on a ceramic board(7.0×5.0×0.6mm).

^{*3} Pulsed

● Electrical characteristic curves(T_a = 25°C)

Fig.1 Ground Emitter Propagation Characteristics

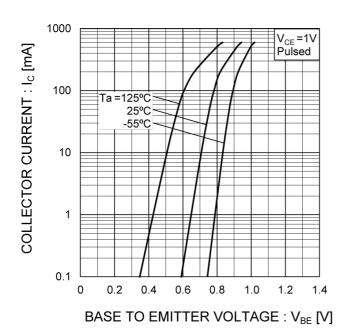
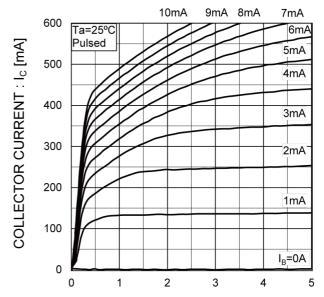


Fig.2 Grounded Emitter Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: VCE [V]

Fig.3 DC Current Gain vs. Collector Current (I)

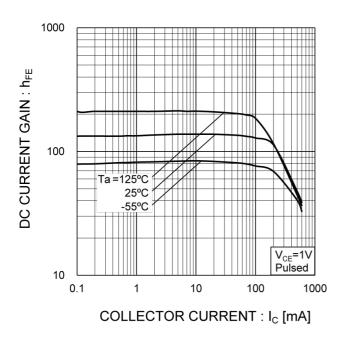
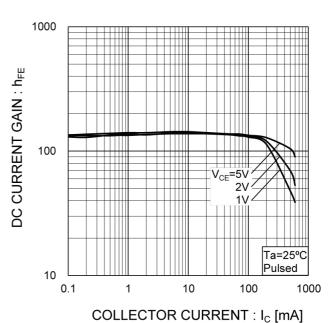


Fig.4 DC Current Gain vs. Collector Current (II)



● Electrical characteristic curves(T_a = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current(I)

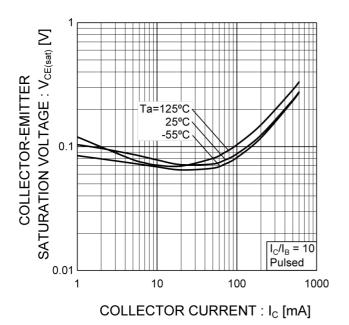


Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current(II)

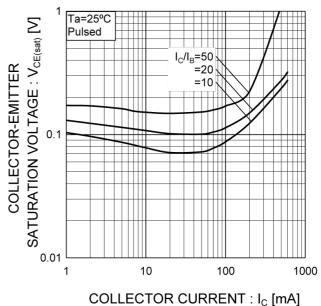


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current (I)

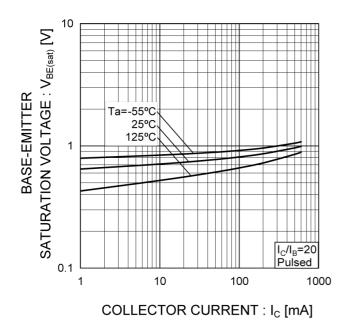
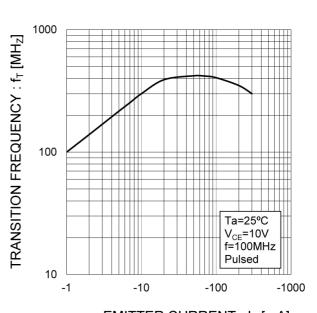


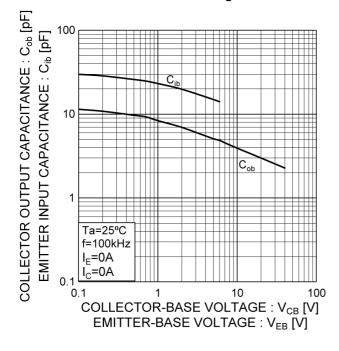
Fig.8 Gain Bandwith Product vs. Emitter Current

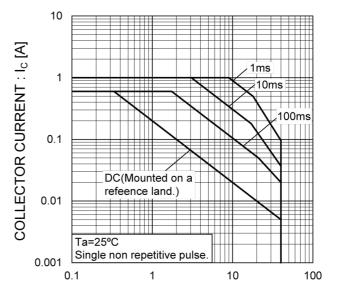


● Electrical characteristic curves(T_a = 25°C)

Fig.9 Collector Output Capacitance vs.
Collector-Base Voltage
Emitter Input Capacitance vs.
Emitter-Base Voltage

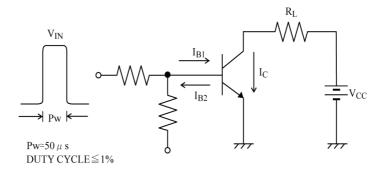
Fig.10 Safe Operating Area

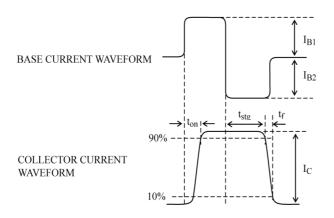




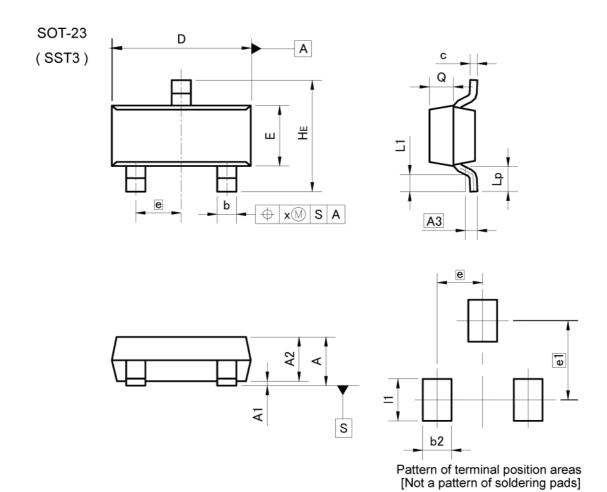
COLLECTOR TO EMITTER VOLTAGE: VCE [V]

SWITCHING TIME TEST CIRCUIT





Dimensions



| DIM MILIM | | ETERS | INCHES | |
|-----------|------|-------|---------------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.90 | 1.20 | 0.035 | 0.047 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| A2 | 0.85 | 1.15 | 0.033 | 0.045 |
| A3 | 0.3 | 25 | 0.0 | 10 |
| b | 0.35 | 0.50 | 0.014 | 0.020 |
| С | 0.09 | 0.25 | 0.004 | 0.010 |
| D | 2.70 | 3.10 | 0.106 | 0.122 |
| E | 1.20 | 1.50 | 0.047 | 0.059 |
| е | 0.95 | | 0.037 | |
| HE | 2.20 | 2.60 | 0.087 | 0.102 |
| L1 | 0.20 | 00 | 0.008 | _ |
| Lp | 0.30 | 2,-3 | 0.012 | - |
| Q | 0.40 | 0.60 | 0.016 | 0.024 |
| х | - ,, | 0.10 | e | 0.004 |

| DIM | MILIM | ETERS | INCHES | | |
|-----|-------|-------|--------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| b2 | | 0.60 | - | 0.024 | |
| e1 | 1. | 70 | 0.067 | | |
| 11 | -2 | 0.90 | - | 0.035 | |

Dimension in mm/inches



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| JAPAN | USA | EU | CHINA |
|---------|-----------|------------|-----------|
| CLASSⅢ | CL ACCIII | CLASS II b | CI VCCIII |
| CLASSIV | CLASSII | CLASSⅢ | CLASSⅢ |

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 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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